

OVERVIEW

The NT7450 family of dot matrix LCD drivers are designed for the display of characters and graphics. The drivers generate LCD drive signals derived from bit mapped data stored in an internal RAM.

The drivers are available in two configurations. The NT7450 family drivers incorporate innovative circuit design strategies to achieve very low power dissipation at a wide range of operating voltages.

These features give the designer a flexible means of implementing small to medium size LCD displays for compact, low power systems.

- The NT7450 which is able to drive two lines of twelve characters each.
- The NT7451 which is able to drive 80 segments for extention.

FEATURES

- Fast 8-bit MPU interface compatible with 80-and 68-family microcomputers
- Many command set
- Total 80 (segment+common) drive sets
- Low power 30 μW at 2 kHz external clock
- Wide range of supply voltages

VDD-Vss: +2.7~+5.5V VDD-V5: +3.5~+13.0V • Low-power CMOS

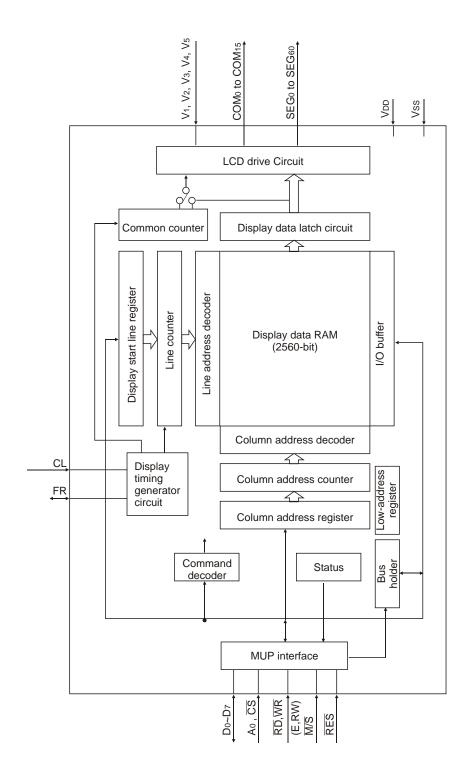
Line-up

Product	Clock Fr	equency	Applicable Driver	Number of SEG	Number of CMOS	Duty
Name	On-Chip	External	Applicable Billo	Drivers	Drivers	Daty
NT74500A	18kHz	18kHz	NT74500A , NT74510A	61	16	1/16 , 1/32
NT74510A	-	18kHz	NT7450oA	80	0	1/8 to 1/32
NT7450AA	-	2kHz	NT74500A, NT74510A	61	16	1/16 , 1/32
NT7451AA	-	2kHz	NT74500A	80	0	1/8 to 1/32



BLOCK DIAGRAM

An example of NT7450AA





PIN DESCRIPTION

(1) Power Pins

Name	Description
VDD	Connected to the +5V dc power. Common to the Vcc MPU power pin.
Vss	0 Vdc pin connected to the system ground.
V1,V2,V3,V4,V5	Multi-level power supplies for LCD driving. The voltage determined for each liquid crystal cell is divided by resistance or it is converted in impedance by the op amp, and supplied. These voltages must satisfy the following: $VDD \ge V1 \ge V2 \ge V3 \ge V4 \ge V5$

(2) System Bus Connection Pins

() -)	
D7 to D0	Three-state I/O. The 8-bit bidirectional data buses to be connected to the 8- or 16-bit standard MPU data buses.
A0	Input. Usually connected to the low-order bit of the MPU address bus and used to identify the data or a command. A0=0: D0 to D7 are display control data. A0=1: D0 to D7 are display data.
RES	Input. When the RES signal goes the 68-series MPU is initialized, and when it goes, the 80-series MPU is initialized. The system is reset during edge sense of the RES signal. The interface type to the 68-series or 80-series MPU is selected by the level input as follows:High level: 68-series MPU interface Low level: 80-series MPU interface
CS	Input. Active low. Effective for an external dock operation model only. An address bus signal is usually decoded by use of chip select signal, and it is entered. If the system has a built-in oscillator, this is used as an input pin to the oscillator amp and an Rf oscillator resistor is connected to it. In such case, the \overline{RD} , \overline{WR} and E signals must be \overline{OR} ed with the \overline{CS} signals and entered.
E (RD)	If the 68-series MPU is connected: Input. Active high. Used as an enable clock input of the 68-series MPU. If the 80-series MPU is connected: Input. Active low. The RD signal of the 80-series MPU is entered in this pin. When this signal is kept low, the NT7450 data bus is in the the output status.
R/W (WR)	 If the 68-series MPU is connected: Input. Used as an input pin of read control signals (if R/W is high) or write control signals (if low). If the 80-series MPU is connected: Input. Active low. The WR signal of the 80-series MPU is entered in this pin. A signal on the data bus is fetched at the rising edge of WR signal.



Product			Pad Numl	Pad Number							
Name	74	75	96 to 100, 1 to 11	93	94	95					
NT74500A	OSC1	OSC2	COM0 to COM15*	M/S	V4	V1					
NT74510A	CS	CL	SEG76 to SEG61	SEG79	SEG78	SEG77					
NT7450AA	CS	CL	COM0 to COM15*	M/S	V4	V1					
NT7451AA	cs	CL	SEG76 to SEG61	SEG79	SEG78	SEG77					

NT7450: Common outputs COM0 to COM15 of the master LSI correspond to COM31 to COM16 of the slave LSI.



(3) LCD Drive Circuit Signals

CL This is at each used: Input/This is \(\lambda \) Cor \(\cdot \) Dec \(\cdot \) Cor \(\cdot \) Dec \(\cdot \) SEGn SEGn Output The O select the re COMn Input. The m	th signal falling and reas an output pin for toutput. s an I/P pin of LCD A lection nmon oscillator buit- licate segment mode t. utput pin for LCD colled by the combination The segment t. output we t.	n signal to rising edgethe oscilla AC signals in model: el: lumn (segon of displ	count up to es. If the solution amp are solution amp are solutions, and connocute of Marchael an	the line counter and common country system has a built-in oscillator. It and an Rf oscillator resistor is connected to the M terminal of common l/S is 1; //S is 0 Ing. A single level of VDD, V2, V3 ontents and RF signal.	his is nected to on driver.
FR This is I/O se - Cor - Dec - Dec - Cor - Dec - Cor - Dec - Dec - Cor - Dec	s an I/P pin of LCD A lection nmon oscillator buit-licate segment mode t. utput pin for LCD colled by the combination of the lection of the l	in model: el: lumn (seg on of displ	Output if Management of the last of the la	ng. A single level of VDD, V2, V3 ontents and RF signal.	and V5 is
SEGn Outpu The C select the re COMn Input. The m	utput pin for LCD coled by the combination FR signal Cutput Size t.	on of displ	ay RAM co	ontents and RF signal.	
Output The Conselect the residence COMn Input. The modern of the conservation of the	Output town	ommon (Ic	1 1 1 1 1 2 2 2 3 3 4 3 4 3 4 3 4 3 4 4 4 4 4 4 4	0 1 0 v3 v3	
COMn Input. The C	Cutput leve	ommon (Ic	J 1 L → V= I -	0 1 0 V3 V3 V3 V3 V3 V3 V3	
COMn Input. The C	t. Output pin for LCD co	ommon (Ic	ow) driving	/2 V5 V3	
COMn Input. The C	output pin for LCD co		w) driving		
Input. The m	ed by the combination verse common outpo		mon count	A single level of VDD, V1, V4 an er output and RF signal. The sla an the master LSI.	
The m	FR elgnel		¹	<u> </u>	
The m	Counter out	lput		<u>0</u> 1 D	
The m	Output level	. —	V5	V1 V00 V4	
LSI or When	peration mode).	ect the ma	ster LSI op	or the NT7450. Deration mode) or Vss (to select t COM0 to COM15, OSC1 (CS), a	
		M/S	FR	COM output OSC1	OSC2
		VDD	Output	COM0 to COM15 Input	Output
	NT74500A				Input



BLOCK DESCRIPTION

System Bus MPU interface

1. Selecting an interface type

The NT7450 series transfers data via 8-bit bidirectional data buses (D0 to D7). As its Reset pin has the MPU interface select function, the 80-series MPU or the 68-series MPU can directly be connected to the MPU bus by the selection of high or low \overline{RES} signal level after reset (see Table 1).

When the $\overline{\text{CS}}$ signal is high, the NT7450 series is disconnected from the MPU bus and set to stand by. However, the reset signal is entered regardless of the internal setup status.

Table1

RES signal input level	MPU type	A0	Е	R/W	CS	D0 to D7
Active low	68-series	^	1	1	↑	↑
Active high	80-series	^	RD	WR	↑	↑

Data transfer

The NT7450 and NT7451 drivers use the A0, E(or \overline{RD}) and R/W (or \overline{WR}) signals to transfer data between the system MPU and internal registers. The combinations used are given in the table blow.

In order to match the timing requirements of the MPU with those of the display data RAM and control registers all data is latched into and out of the driver. This introduces a one cycle delay between a read request for data and the data arriving. For example when the MPU executes a read cycle to access display RAM the current contents of the latch are placed on the system data bus while the desired contents of the display RAM are moved into the latch

This means that a dummy read cycle has to be executed at the start of every series of reads. See Figure 1. No dummy cycle is required at the start of a series of writes as data is transferred automatically from the input latch to its destination.

Common	68 MPU	80	MPU	Franction
Α0	R/W	RD	WR	Function
1	1	0	1	Read display data
1	0	1	0	Write display data
0	1	0	1	Read status
0	0	1	0	Write to internal register (command)

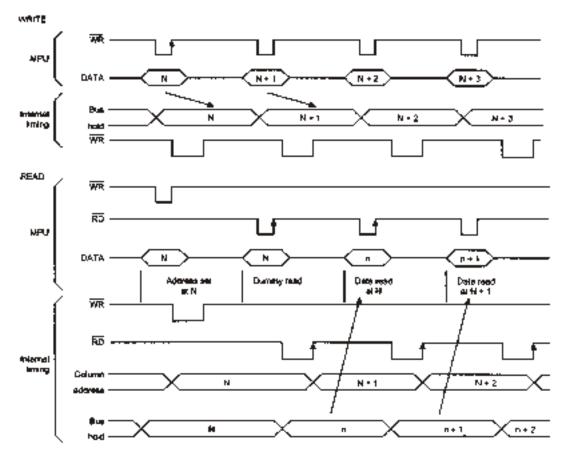


Figure 1 Bus Buffer Delay

Data transfer

When the Busy flag is logical 1, the NT7450 series is executing its internal operations. Any command other than Status Read is rejected during this time. The Busy flag is output at pin D7 by the Status Read command. If an appropriate cycle time (tcyc) is given, this flag needs not be checked at the beginning of each command and , therefore, the MPU processing capacity can greatly be enhanced.

Display Start Line and Line Count Registers

The contents of this register form a pointer to a line of data in display data RAM corresponding to the first line of the display (COM0), and are set by the Display Start Line command.

The contents of the display start line register are copied into the line count register at the start of every frame, that is on each edge of FR. The line count register is incremented by the CL clock once for every display line, thus generating a pointer to the current line of data, in display data RAM, being transferred to the segment driver circuits.

Column Address Counter

The column address counter is a 7-bit preset table counter that supplies the column address for MPU access to the display data RAM. See figure 2. The counter is incremented by one every time the driver receives a Read or Write Display Data command. Addresses above 50H are invalid, and the counter will not increment past this value. The contents of the column address counter are set with the Set Column Address command.



Page Register

The page resiter is a 2-bit register that supplies the page address for MPU access to the display data RAM. See Figure 2. The contents of the page register are set by the Set Page Register command.

Display Data RAM

The display data RAM stores the LCD display data, on a 1-bit per pixel basis. The relation-ship between display data, display address and the display is shown in Figure 2.

Common Timing Generator Circuit

Generates common timing signals and FR frame signals from the CL basic clock. The 1/16 or 1/32 duty (for NT7450) can be selected by the Duty Select command. If the 1/32 duty is selected for the NT7450 the 1/32 duty is provided by two chips consisting of the master and slave chips in the common multi-chip mode.

NT7450



Display Data Latch Circuit

This latch stores one line of display data for use by the LCD driver interface circuitry. The output of this latch is controlled by the Display ON/OFF and Static Drive ON/OFF commands.

LCD Driver Circuit

The LCD driver circuitry generates the 80-4-level signals used to drive the LCD panel, using output from the display data latch and the common timing generator circuitry.

Display Timing Generator

This circuit generates the internal display timing signal using the basic clock, CL, and the frame signals, FR.

FR is used to generate the dual frame AC-drive wave-from (type B drive) and to lock the line counter and common timing generator to the system frame rate.

CL is used to lock the line counter to the system line scan rate. If a system uses both NT7450s and NT7451s they must have the same CL frequency rating.

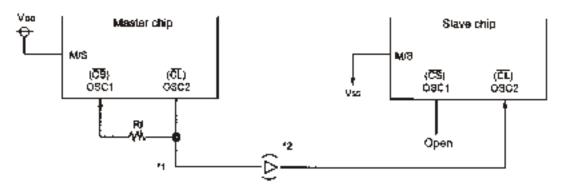


Oscillator Circuit (NT74500A)

A low power-consumption CR oscillator for adjusting the oscillation frequency using Rf oscillation resistor only. This circuit generates a display timing signal. Some of NT7450 series models have a built-in oscillator and others use an external clock. This difference must be checked before use.

Connect the Rf oscillation resistor as follows. To suppress the built-in oscillator circuit and drive the MPU using an external clock, the clock having the same phase as the OSC2 of mater chip into OSC2 of the slave chip.

· MPU having a built-in oscillator



- *1 If the parasitic capacitance of this section increases, the oscillation frequency may shift to the lower frequency. Therefore, the Rf oscillation frequency must be reduced below the specified level.
- *2 A CMOS buffer is required if the oscillation circuit is connected to two or more slave MPU chips.

Resst Cricuit

Detects a rising or falling edge of an RES input and initializes the MPU during power-on.

- · Initialization status
- 1. Display is off.
- 2. Display start line register is set to line 1.
- 3. Static drive is turned off.
- 4. Column address counter is set to address 0.
- 5. Page address register is set to page 3.
- 6. 1/32 duty NT7450 is selected.
- 7. Forward ADC is selected (ADC command D0 is 0 and ADC status flag is 1).
- 8. Read-modify-write is turned off.

The input signal level at RES pin is sensed, and an MPU interface mode is selected as shown on Table 1.

For the 80-series MPU, the \overline{RES} input is passed through the inverter and the active high reset signal must be entered. For the 68-series MPU, the active low reset signal must be entered.

As shown for the MPU interface (reference example), the $\overline{\text{RES}}$ pin must be connected to the Reset pin and reset at the same time as the MPU initialization.

If the MPU is not initialized by the use of \overline{RES} pin during power-on, an unrecoverable MPU failure may occur. When the Reset command id issued, initialization.

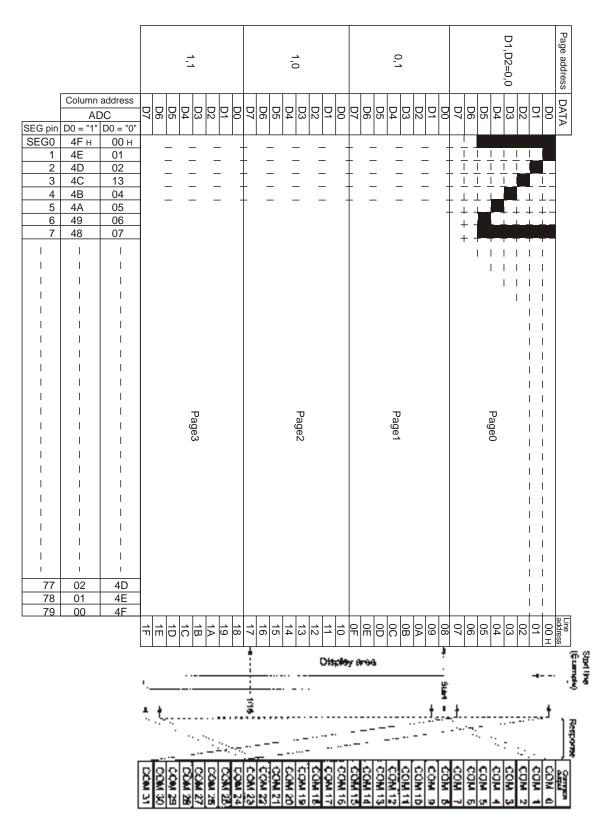


Figure 2 Display Data RAM Addressing

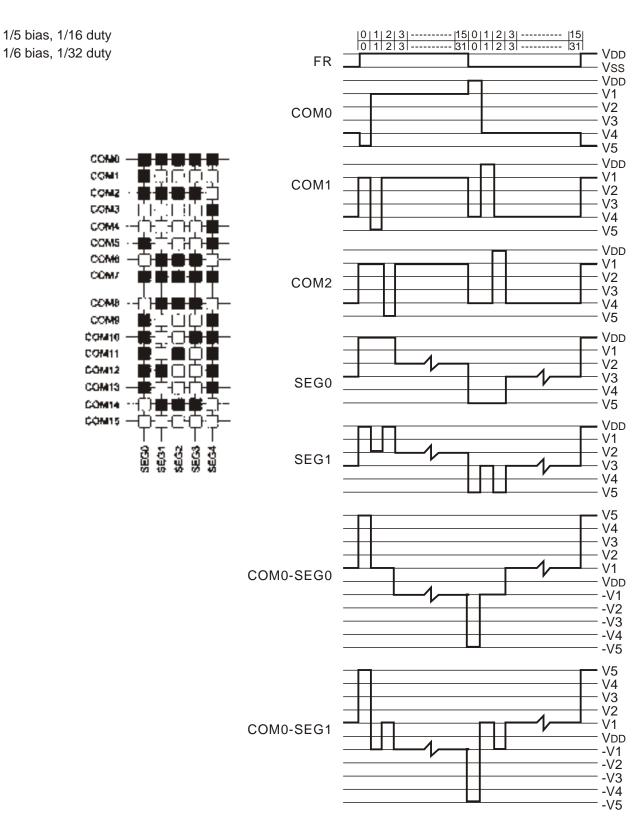


Figure 4 LCD drive waveforms example



COMMANDS

Summary

0.0000000000000000000000000000000000000					(ode	9					Franction			
Command	Α0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	Function			
Display On/Off	0	1	0	1	0	1	0	1	1	1	0/1	Turns display on or off.			
Display On/On	Ŭ	'	0				0	'	'	'	0/ 1	1: ON, 0: OFF			
Display start line	0	1	0	1	1	0		play				Specifies RAM line corresponding to top line			
Display start line	Ŭ	'					add	dres	s (0	to 3	31)	of display.			
Set page address	0	1	0	1	0	1	1	1	0		ige (Sets display RAM page in page address			
	Ľ	'				Ċ		'		(0 t	o 3)	9			
Set column	0	1	0	0	Co	lumi	n ad	dres	ss (() to	79)	Sets Display RAM column address in			
(Segment) address	Ŭ	'						u. oc	, 00	, 10	. 0,	column address register.			
												Reads the following status:			
												BUSY 1: Busy			
												0: Ready			
						ON/OFF)t					ADC 1: CW output			
Read status	0	0	1	Busy	ADC	Ž	Reset	0	0	0	0	0: CCW output			
				В	⋖	0	2					NO/OFF 1: Display off			
												0: Display on			
												RESET 1: Being reset			
												0: Nomal			
Write display data	1	1	0									Writes data from data bus into display RAM.			
Dood display data	_		4									Reads data from display RAM onto data			
Read display data	1	0	1									bus.			
Select ADC	0	1	0	1	0	1	0	0	0	0	0/1	0:CW output, 1:CCW output			
Statis drive		1	0	1	0	1	0		1		0/1	Selects static driving operation.			
ON/OFF	0	1	U	1	U	'	U	0	'	0	0/ 1	1:Static frive, 0:Normal driving			
Select duty	0	1	0	1	0	1	0	1	0	0	0/1	Selets LCD duty cycle			
Select duty		'	U			_	0	'	U	U	0/ 1	1:1/32, 0:1/16			
Read-Modify-Write	0	1	0	1	1	1	0	0	0	0	0	Read-modify-write ON			
End	0	1	0	1	1	1	0	1	1	1	0	Read-modify-write OFF			
Reset	0	1	0	1	1	1	0	0	0	1	0	Software reset			



Command Description

Table 3 is the command table. The NT7450 series identifies a data bus using a combination of A0 and R/W (RD or WR) signals. As the MPU translates a command in the internal timing only (independent from the external clock), its speed is very high. The busy check is usually not required.

Display ON/OFF

		R/W									
Α0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	
0	0	0	1	0	1	0	1	1	1	D	,

AEH, AFH

This command turns the display on and off.

D=1: Display OND=0: Display OFF

Display Start Line

This command specifies the line address shown in Figure 3 and indicates the display line that corresponds to COMO. The display area begins at the specified line address and continues in the line address increment direction. This area having the number of lines of the specified display duty is displayed. If the line address is changed dynamically by this command, the vertical smooth scrolling and paging can be used.

		R/W								
A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	1	0	A4	А3	A2	A1	A0

C0H to DFH

This command loads the display start line register.

A	4	АЗ	A2	A1	A0	Line Address
0		0	0	0	0	0
0		0	0	0	0	1
						:
						:
1		1	1	1	1	31

See Figure 2.

Set Page Address

This command specifies the page address that corresponds to the low address of the display data RAM when it is accessed by the MPU. Any bit of the display data RAM can be accessed when its page address and column address are specified. The display status is not changed even when the page address is changed.

		R/W								
A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	1	1	0	A1	A0

B8H to BBH

This command loads the page address register.

A1	A0	Page
0	0	0
0	1	1
1	0	2
1	1	3

See Figure 2.



Set Column Address

This command specifies a column address of the display data RAM. When the display data RAM is accessed by the MPU continuously, the column address is incremented by 1 each time it is accessed from the set address. Therefore, the MPU can access to data continuously. The column address stops to be incremented at address 80, and the page address is not changed continuously.

		R/W								
Α0	\overline{RD}	WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	0	A6	A5	A4	А3	A2	A1	A0

00H to 4FH

This command loads the column address register.

A6	A5	A4	А3	A2	A1	Α0	Column Address
0	0	0	0	0	0	0	0
0	0	0	0	0	0	0	1
							:
							:
1	0	0	1	1	1	1	79

Read Status

		R/W								
A0	\overline{RD}	WR	D7	D6	D5	D4	D3	D2	D1	D0
0	Ō	1	BUSY	ADC	ON/OFF	RESET	0	0	0	0

Reading the command I/O register (A0=0) yields system status information.

· The busy bit indicates whether the driver will accept a command or not.

Busy=1: The driver is currently executing a command or is resetting. No new command will be accepted.

Busy=0: The driver will accept a new command.

· The ADC bit indicates the way column addresses are assigned to segment drivers.

ADC=1: Normal. Column address $n \rightarrow \text{segment driver } n$.

ADC=0: Inverted. Column address 79-u → segment driver u.

· The ON/OFF bit indicates the current status of the disply.

It is the inverse of the polarity of the display ON/OFF command.

ON/OFF=1: Display OFF ON/OFF=0: Display ON

• The RESET bit indicates whether the driver is executing a hardware or software reset or if it is in normal operation mode.

RESET=1: Currently executing reset command.

RESET=0: Normal operation

Write Display Data

		R/W								
Α0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0			W	rite d	ata			



Read Display Data

		R/W								
A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0
1	0	1			R	ead d	ata			

Reads 8-bit of data from the data I/O latch, updates the contents of the I/O latch with display data from the display data RAM location specified by the contents of the column address and page address registers and then increments the column address register.

After loading a new address into the column address register one dummy read is required before valid data is obtained.

Select ADC

		R/W									
A0	RD	WR	D7	D6	D5	D4	D3	D2		D0	
0	1	0	1	0	1	0	0	0	0	D	A0H, A1H

This command selects the relationship between display data RAM column addresses and segment drivers.

D=1: SEG0 ← column address 4FH,...(inverted)

D=0: SEG0 ←

This command is provided to reduce restrictions on the placement of driver ICs and routing of traces during printed circuit board design. See Figure 2 for a table of segments and column addresses for the two values of D.

Static Drive ON/OFF

		R/W								
A0	\overline{RD}	WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	0	1	0	D

A4H, A5H

Forces display on and all common outputs to be selected.

D=1: Static drive on D=0: Static drive off

Select Duty

		R/W								
A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	1	0	1	0	1	0	0	D

A8H, A9H

This command sets the duty cycle of the LCD drive and is only valid for the NT7450. It is invalid for the NT7451 which performs passive operation. The duty cycle of the NT7451 is determined by the externally generated FR signal.

NT7450

D=1: 1/32 duty cycle D=0: 1/16 duty cycle

When using the NT74500A, (having a built-in oscillator) and the NT74510A continuously, set the duty as follows:

NT74500A	NT74510A
1/32	1/32
1/16	1/16



Read-Modify-Write

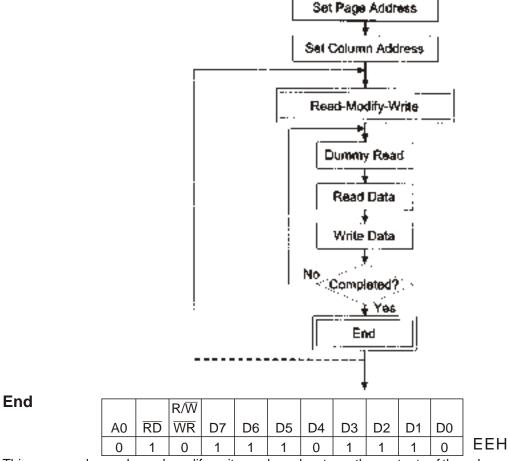
		R/W									
A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	
0	1	0	1	1	1	0	0	0	0	0	E0H

This command defeats column address register auto-incerment after data reads. The current conetents of the column address register are saved. This mode remains active until an End command is received.

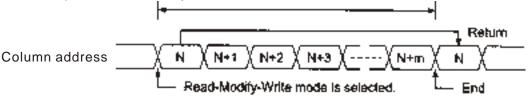
· Operation wequence during cursor display

When the End command is entered, the column address is returned to the one used during input of Read-Modify-Write command. This Function can reduce the load of MPU when data change is repeated at a specific display area (such as cursor blinking).

* Any command other than Data Read or Write can be used in the Read-Modify-Write mode. However, the Column Address Set command cannot be used.



This command cancels read-modify-write mode and restores the contents of the column address register to their value prior to the receipt of the Read-Modify-Write command.



NOV.2000 16/24



Reset

		R/W									
Α0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	
0	1	0	1	1	1	0	0	0	1	0	E2H

This command clears

- · the display start line register.
- \cdot and set page address register to 3 page.

It does not affect the contents of the display data RAM.

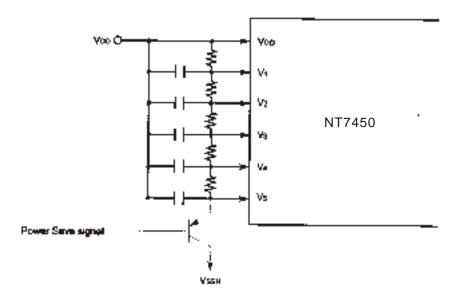
When the power supply is turned on, a Reset signal is entered in the $\overline{\text{RES}}$ pin. The Reset command connot be used instead of this Reset signal.

Power Save (Combination command)

The Power Save mode is selected if the static drive is turned ON when the display is OFF. The current consumption can be reduced to almost the static current level. In the Power Save mode:

- (a) The LCD drive is stopped, and the segment and common driver outputs are set to the VDD level.
- (b) The external oscillation clock input is inhibited, and the OSC2 is set to the floating mode.
- (c) The display and operation modes are kept.

The Power Save mode is released when the display is turned ON or when the static drive is turned OFF. If the LCD drive voltage is supplied from an external resistance divider circuit, the current passing through this resistor must be cut by the Power Save signal.



If the LCD drive power is generated by resistance division, the resistance and capacitance are determined by the LCD panel size. After the panel size has been determined, reduce the resistance to the level where the display quality is not affected and reduce the power consumption using the divider resistor.



SPECIFICATIONS

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage(1)	Vss	-8.0 to +0.3	V
Supply voltage(2)	V5	-16.5 to +0.3	V
Supply voltage(3)	V1,V4,V2,V3	V5 to +0.3	V
Input voltage	VIN	Vss-0.3 to +0.3	V
Output voltage	Vo	Vss-0.3 to +0.3	V
Power dissipation	PD	250	mW
Operating temperature	Topr	-40 to +85	deg. C
Storage temperature	Tstg	-65 to +150	deg. C
Soldering temperature time at lead	Tsol	260, 10	deg. C, sec

Notes:1. All voltages are specified relative to VDD=0V.

- 2. The following relation must be always hold $VDD\!\ge\!V1\!\ge\!V2\!\ge\!V3\!\ge\!V4\!\ge\!V5$
- 3. Exceeding the absolute maximum ratings may cause permanent damage to the device. Functional operation under these conditions is not implied.
- 4. Moisture resistance of flat packages can be reduced by the soldering process, so care should be taken to avoid thermally stressing the package during board assembly.

Electrical Specifications

DC Characteristics

Ta=-20 to 75 deg. C, VDD=0V unless stated otherwise

		0	0	PC		Ratii	ng	11	A L' L L . D'
Para	meter	Symbol	Con	dition	Min.	Тур.	Max.	Unit	Applicable Pin
	voltage(1) See commended	Vss			-5.5	-	-2.7	V	Vss
	Recommended	V5			-13.0	-	-3.5	V	V5
Operating	Allowable				-13.0	-	-		See note 10.
voltage(2)	Allowable	V1,V2			0.6xV5	-	Vdd	V	V1,V2
	Allowable	V3,V4			V5	-	0.4xV5	V	V3,V4
		VIHT			Vss+2.0	-	Vdd		Coo noto 2 9 2
High-level input voltage		VIHC			0.2xVss	-	Vdd		See note 2 & 3.
I ligit level	r light-level input voltage		Vss=-3V		0.2xVss	-	Vdd		Can mate 0 9 0
		VIHC	Vss=-3V		0.2xVss	-	Vdd	V	See note 2 & 3.
		VILT			Vss		Vss+0.8		Caa mata 0 0 0
		VILC			Vss		0.8xVss		See note 2 & 3.
Low-level	input voltage	VILT	Vss=-3V		Vss		0.85xVss		0
		VILC	Vss=-3V		Vss		0.8xVss		See note 2 & 3.
		Voht			Vss+2.4	-	-		0000
		Vohc1			Vss+2.4	-	-	V	OSC2
I li ada ti la coa		VOHC2		μ	0.2xVss	-	•		See note 4 & 5.
Hight-leve	l output voltage	Vонт		IOH=-2mA	0.2xVss				0
		Vohc1		IOH=-2mA	0.2xVss			V	See note 4 & 5.
		VOHC2		IOH=-2 μ A	0.2xVss				OSC2



DC Characteristics(Cont'd)

Ta=-20 to 75 deg. C, VDD=0V unless stated otherwise

Parameter	Symbol	Condition					Unit	Applicable Pin
Parameter	Syllibol	Conditio) 	Min.	Тур.	Max.	Ollic	Applicable Fill
	Volt	lol = 3.0mA		-	-	Vss+0.4		OSC2
	VolC1	loL = 2.0mA		-	-	Vss+0.4	V	
Low-level output voltage	Volc2	$lol = 120 \muA$		-	-	0.8xVss		See note 4 & 5.
	Volt	Vss = -3V	loL = 2mA			0.8xVss		See note 4 & 5.
	VolC1		lol = 3mA			0.8xVss	V	OSC2
	VolC2		$lol = 50 \mu A$			0.8xVss		0302
Input leakage current	lL1		-1.0	-	1.0	μ A	See note 6.	
Output leakage current	lL0			-3.0	-	3.0	μ	See note 7.
LCD driver ON resistan	ce RON		V5 = -5.0V	-	-	7.5	Ω	SEG0 to 79, COM0 to 15,
205 anver erv reesear.		V5 = -3.5V		-	-	50.0	2.2	See note 11
Static current dissipation	c current dissipation IDDQ				-	1.0	μ	VDD
			fcL = 2kHz	-	-	10		VDD
			$Rf = 1M\Omega$	-	-	40	μ	See note 12,
				-	-	25		13 & 14.
Dynamic current	IDD(1)				-	9	μ	VDD
dissipation			Ω		-	25		See note 12 & 13.
				-	300	500		
	I _{DD(2)}	Vss = -3V, Druing access to	yc = 200kHz		150	300	μ	See note 8.
Input leakage current	CIN	Ta = 25 deg. C, f	= 1 MHz	-	5.0	8.0		All input pins
Oscillation frequency	fosc	Rf = $1.0M\Omega \pm 2\%$ Vss = $-0.5V$ Rf = $1.0 \Omega \pm$	15 11	18 16	21 21		See note 9.	
C Reset time	tR		1.0	-		μ	RES See note 15.	

Vss = -3VVss = -3V

Ta = 25deg.

CS = CL = VDD

During display

Notes:1. Operation over the specified voltage range is guaranteed, except where the supply voltage changes suddenly during CPU access.

V5 = -5.0V 2. A0, D0 to $\overline{D7}$, $E(or \overline{RD})$, R/\overline{W} (or \overline{WR}) and \overline{CS}

3. CL, FR, M/\overline{S} and \overline{RES}

During display 4. D0 to D7

V5 = -5V 5. FR

 $V_{SS} = -3V$ 6. A0, E (or \overline{RD}), R/ \overline{W} (or \overline{WR}), \overline{CS} , CL, M/ \overline{S} and \overline{RES}

During access tycy = 200kHz

NOV.2000 19/24

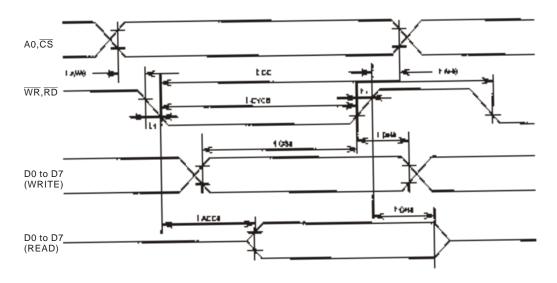


- 7. When D0 to D7 and FR are high impedance.
- 8. During continual write access frequency.
- 9. See figure below for details
- 10. See figure below for details
- 11. For a voltage differential of 0.1 V between input (V1,..., V4) and output (COM, SEG) pins. All voltages within specified operating voltage range.
- 12. NT7450 and NT7451 only. Does not include transient currents due to stray and panel capacitances.
- 13. NT7450 only. Does not include transient currents due to stray and panel capacitances.
- 14. NT7451 only. Does not include transient currents due to stray and panel capacitances.
- 15.tR (Rest time) represents the time from the RES signal edge to the completion of rest of the internal circuit. Therefore, the NT7450 series enters the normal operation status after this tR.



AC Characteristics

· MPU Bs Read/Write I (in-family MPU)



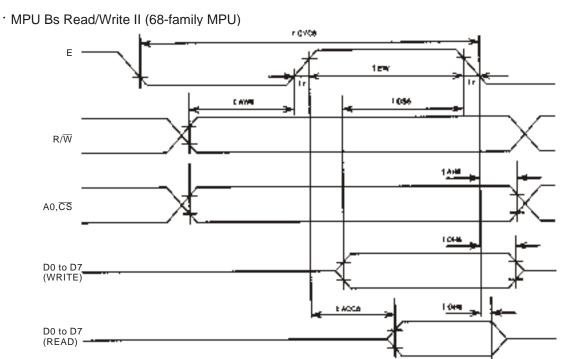
Ta=-20 to 75 deg. C, Vss=-5.0V± 10% unless stated otherwise

5 .			Ra	nting		0
Parameter	Symbol	Condition	Min.	Max.	Unit	Signal
Address hold time	tAH8		10	-	ns	A0 CC
Address setup time	tAW8		20	-	ns	A0, CS
System cycle time	tCYC8		1000	-	ns	. WD DD
Control pulsewidth	tcc		200	-	ns	WR,RD
Data setup time	tDS8		80	-	ns	
Date hold time	tDH8		10	-	ns	D0 (D7
RD access time	tACC8	Q	-	90	ns	D0 to D7
Output disable time	tCH8	CL=100pF	10	60	ns	
Rise and fall time	tr, tf	-	-	15	ns	-

(Vss=-2.7 to -4.5V, Ta=-20 to +75 $^{\circ}$ C)

		0 1141	Ra	ating			
Parameter	Symbol	Condition	Min.	Max.	Unit	Signal	
Address hold time	tAH8		20	-	ns	A0 CS	
Address setup time	tAW8		40	-	ns	A0, CS	
System cycle time	tCYC8		2000	-	ns	WD DD	
Control pulsewidth	tcc		400	-	ns	WR,RD	
Data setup time	tDS8		160	-	ns		
Date hold time	tDH8		20	-	ns	D0 t- D7	
RD access time	tACC8	01 100 -	-	180	ns	D0 to D7	
Output disable time	tCH8	CL=100pF	20	120	ns		
Rise and fall time	tr, tf	-	-	15	ns	-	





Ta=-20 to 75 deg. C, Vss=-5.0V \pm 10% unless stated otherwise

				Ra	iting		6: 1		
Paramet	er	Symbol	Condition	Min.	Max.	Unit	Signal		
System cycle	e time	tCYC6		1000	-	ns			
Address set	up time	tAW6		20	-	ns	A0, CS,R/W		
Address hold	d time	tAH6		10	-	ns			
Data setup t	ime	tDS6		80	-	ns			
Data hold tin	ne	tDH6		10	-	ns	D0 to D7		
Output disab	ole time	tOH6	CL=100pF	10	60	ns	D0 to D7		
Access time		tACC6	0 11	-	90	ns			
Enable	Read	tEW		100	-	ns	E		
pulsewidth Write		[⊏VV		80	-	ns			
Rise and fall time		tr, tf	-	-	15	ns	-		

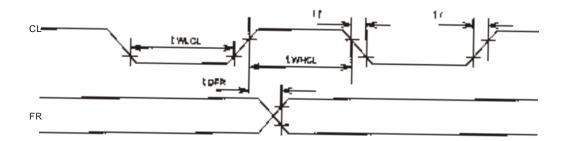
(Vss=-2.7 to -4.5V, Ta=-20 to +75 $^{\circ}$ C)

_				Ra	iting				
Paramet	ter	Symbol	Condition	Min.	Max.	Unit	Signal		
System cycl	e time ^{*1}	tCYC6		2 000	-	ns			
Address set	up time	tAW6		40 -		ns	A0, CS,R/W		
Address hole	d time	tAH6		20	-	ns			
Data setup t	ime	tDS6		160	-	ns			
Data hold tin	ne	tDH6		20	-	ns	D0 to D7		
Output disat	ole time	tOH6	CL=100pF	20	120	ns	D0 to D7		
Access time		tACC6)	-	180	ns			
Enable Read		tEW		200	-	ns	F		
pulsewidth Write		[⊏vv		160	-	ns	E		
Rise and fall time		tr, tf	-	-	15	ns	-		

Notes:1.tcyc6 is the cycle time of CS. E=H, not the cycle time of E.



· Display Control Signal Timing



Input

Ta=-20 to 75 deg. C, Vss=-5.0V \pm 10% unless stated otherwise

		0 1141		Rating			0	
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit	Signal	
Low-level pulsewidth	twlcl		35	-	-	μs		
High-level pulsewidth	tWHCL		35	-	-	μ	CL	
Rise time	tr		-	30	150		CL	
Fall time	tf		-	30	150			
FR delay time	tDFR		-2.0	0.2	2.0	μ	FR	

Vss=-2.7 to -4.5V , Ta=-20 to +75 $^{\circ}$ C

5 ,		0 1141		Rating		1124	0:1
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit	Signal
Low-level pulsewidth	twlcl	-	70	-	-	μ s	
High-level pulsewidth	tWHCL	-	70	-	-	μ	CL
Rise time	tr	-	-	60	300		CL
Fall time	tf	-	-	60	300		
FR delay time	tDFR	-	-4.0	0.4	4.0	μ	FR

Note: The listed input tDFR applies to the NT7450 and NT7451 in slave mode.

Output

Ta=-20 to 75 deg. C, Vss=-5.0V \pm 10% unless stated otherwise

D	0	0 1111		Rating		1124	0:	
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit	Signal	
FR delary time	tDFR	CL=100pF	-	0.2	0.4	μ s	FR	

Vss=-2.7 to -4.5V , Ta=-20 to +75 $^{\circ}\mathrm{C}$

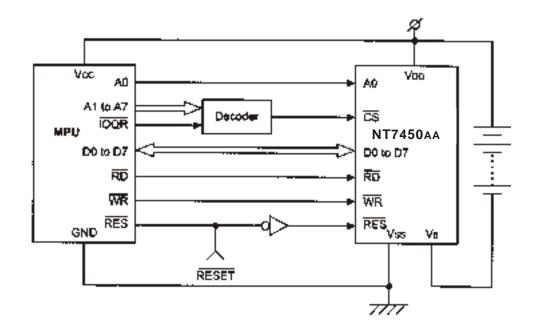
D	0	0 1111		Rating		1124	0:
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit	Signal
FR delary time	tDFR	CL=100pF	-	0.4	8.0	μ s	FR

Note: The listed input tDFR applies to the NT7450 and NT7451 in slave mode.



APPLICATION NOTES

MPU Interface Configuration 80 Family MPU





PAD DIAGRAM

	50	49	48	47	46	45	44 4	3 4	2 41	40	39	38	37	36 3	5 34	33	32	31	
51																			30
52																			29
53																			28
54																			27
55																			26
56																			25
57																			24
58																			23
59																			22
60																			21
61 62																			20 19
63																			18
64																			17
65							Chip		ize: size										16
66							Pa		Size Uni		2 X	11	_						15
67									O 1111	μ									14
68																			13
69																			12
70																			11
71																			10
72																			9
73																			
74 75																			7
76																			5
76 77																			4
78																			3
78 79 80																			2
80																			1
X Y(0	81	82	83	84	85	86	87 8	8	90	91	92	93	94	95 96	97	98	99	100	

X,Y(0,0)



PAD DIAGRAM(NT7450)

Pad No.	Pad name	Х	Υ	Pad No.	Pad name	Х	Υ
1	COM5	3264	380	51	SEG21	95	4481
2	COM6	3264	522	52	SEG20	95	4340
3	COM7	3264	663	53	SEG19	95	4198
4	COM8	3264	805	54	SEG18	95	4057
5	COM9	3264	946	55	SEG17	95	3915
6	COM10	3264	1087	56	SEG16	95	3774
7	COM11	3264	1229	57	SEG15	95	3633
8	COM12	3264	1370	58	SEG14	95	3491
9	COM13	3264	1512	59	SEG13	95	3350
10	COM14	3264	1653	60	SEG12	95	3208
11	COM15	3264	1794	61	SEG11	95	3067
12	SEG60	3264	1936	62	SEG10	95	2926
13	SEG59	3264	2077	63	SEG9	95	2784
14	SEG58	3264	2219	64	SEG8	95	2643
15	SEG57	3264	2360	65	SEG7	95	2501
16	SEG56	3264	2501	66	SEG6	95	2360
17	SEG55	3264	2643	67	SEG5	95	2219
18	SEG54	3264	2784	68	SEG4	95	2077
19	SEG53	3264	2926	69	SEG3	95	1936
20	SEG52	3264	3067	70	SEG2	95	1794
21	SEG51	3264	3208	71	SEG1	95	1653
22	SEG50	3264	3350	72	SEG0	95 95	1512
23	SEG49	3264	3491	73	A0	95 95	1334
24	SEG48	3264	3633	74	OSC1*/CS	95 95	1194
25	SEG47	3264	3774	75	OSC17C3	95 95	1054
26	SEG47	3264	3915	76	RD	95 95	914
27	SEG45	3264	4057	77	WR	95 95	874
28	SEG45 SEG44	3264	1498	78	VSS	95 95	634
26 29	SEG44	3264	4340	79	DB0	95 95	494
30	SEG43 SEG42		4340 4481	80	DB0 DB1	95 95	354
		3264		+			
31 32	SEG41	3037	4474 4474	81 82	DB2 DB3	385 526	95 95
	SEG40	2895 2754		+			
33	SEG39		4474	83	DB4	681	95
34	SEG38	2612	4474	84	DB5	826	95
35	SEG37	2471	4474	85	DB6	974	95
36	SEG36	2330	4474	86	Db7	1117	95
37	SEG35	2188	4474	87	VDD	1257	95
38	SEG34	2047	4474	88	RES	1397	95
39	SEG33	1905	4474	89	FR	1537	95
40	SEG32	1764	4474	90	V5	1679	95
41	SEG31	1623	4474	91	V3	1820	95
42	SEG30	1481	4474	92	V2	1962	95
43	SEG29	1340	4474	93	M/S	2097	95
44	SEG28	1198	4474	94	V4	2231	95
45	SEG27	1057	4474	95	V1	2365	95
46	SEG26	916	4474	96	COM0	2500	95
47	SEG25	774	4474	97	COM1	2634	95
48	SEG24	633	4474	98	COM2	2769	95
49	SEG23	491	4474	99	COM3	2903	95
50	SEG22	350	4474	100	COM4	3037	95



PAD DIAGRAM(NT7451)

Pad No.	Pad name	Х	Υ	Pad No.	Pad name	Х	Υ
1	SEG71	3264	380	51	SEG21	95	4481
2	SEG70	3264	522	52	SEG20	95	4340
3	SEG69	3264	663	53	SEG19	95	4198
4	SEG68	3264	805	54	SEG18	95	4057
5	SEG67	3264	946	55	SEG17	95	3915
6	SEG66	3264	1087	56	SEG16	95	3774
7	SEG65	3264	1229	57	SEG15	95	3633
8	SEG64	3264	1370	58	SEG14	95	3491
9	SEG63	3264	1512	59	SEG13	95	3350
10	SEG62	3264	1653	60	SEG12	95	3208
11	SEG61	3264	1794	61	SEG11	95	3067
12	SEG60	3264	1936	62	SEG10	95	2926
13	SEG59	3264	2077	63	SEG9	95	2784
14	SEG58	3264	2219	64	SEG8	95	2643
15	SEG57	3264	2360	65	SEG7	95	2501
16	SEG56	3264	2501	66	SEG6	95	2360
17	SEG55	3264	2643	67	SEG5	95	2219
18	SEG54	3264	2784	68	SEG4	95	2077
19	SEG53	3264	2926	69	SEG3	95	1936
20	SEG52	3264	3067	70	SEG2	95	1794
21	SEG51	3264	3208	71	SEG1	95	1653
22	SEG50	3264	3350	72	SEG0	95	1512
23	SEG49	3264	3491	73	A0	95	1334
24	SEG48	3264	3633	74	OSC1*/CS	95 95	1194
25	SEG47	3264	3774	75	OSC17CS	95	1054
26	SEG46	3264	3915	76	RD	95	914
27	SEG45	3264	4057	77	WR	95	874
28	SEG44	3264	1498	78	VVIX	95	634
29	SEG43	3264	4340	79	DB0	95	494
30	SEG43	3264	4481	80	DB0 DB1	95	354
31			4474	81	DB1	385	
32	SEG41 SEG40	3037 2895	4474	82	DB2 DB3	526	95 95
33	 	2754		+	DB3 DB4		95
34	SEG39 SEG38	2612	4474 4474	83	DB4 DB5	681 826	95
35	SEG36 SEG37			84			
	SEG37	2471	4474 4474	85	DB6 Db7	974 1117	95 05
36		2330	4474	86			95 05
37	SEG35	2188		87	VDD	1257	95
38	SEG34	2047	4474	88	RES	1397	95
39	SEG33	1905	4474	89	FR	1537	95
40	SEG32	1764	4474	90	V5	1679	95 05
41	SEG31	1623	4474	91	V3	1820	95 05
42	SEG30	1481	4474	92	V2	1962	95
43	SEG29	1340	4474	93	SEG79	2097	95
44	SEG28	1198	4474	94	SEG78	2231	95
45	SEG27	1057	4474	95	SEG77	2365	95
46	SEG26	916	4474	96	SEG76	2500	95
47	SEG25	774	4474	97	SEG75	2634	95
48	SEG24	633	4474	98	SEG74	2769	95
49	SEG23	491	4474	99	SEG73	2903	95
50 NOV 2000	SEG22	350	4474	100	SEG72	3037	95

NOV.2000

